

N-Channel Enhancement Mode MOSFET

Features

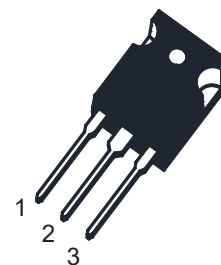
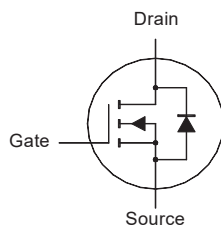
- Low $R_{DS(ON)}$
- Low Gate Charge
- Halogen and Antimony Free(HAF), RoHS compliant

Applications

- For Flyback topologies for example used in Chargers, Adapters, Lighting etc.

Key Parameters

Parameter	Value	Unit
BV_{DSS}	650	V
$R_{DS(ON)}$ Max	190 @ $V_{GS} = 10$ V	m Ω
$V_{GS(th)}$ typ	3	V
Q_g typ	45 @ $V_{GS} = 10$ V	nC



TO-247 Plastic Package
1.Gate 2.Drain 3.Source

Absolute Maximum Ratings (at $T_a = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	650	V
Gate-Source Voltage	V_{GS}	± 30	V
Drain Current	I_D	18 11	A
Peak Drain Current, Pulsed ¹⁾	I_{DM}	64	A
Avalanche Current	I_{AS}	5	A
Single Pulse Avalanche Energy ²⁾	E_{AS}	988	mJ
Total Power Dissipation	P_{tot}	156.2	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	$R_{\theta JC}$	0.8	$^\circ\text{C/W}$
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	40	$^\circ\text{C/W}$

¹⁾ Pulse Test: Pulse Width ≤ 100 μs , Duty Cycle $\leq 2\%$, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ\text{C}$.

²⁾ Limited by $T_{J(MAX)}$, starting $T_J = 25^\circ\text{C}$, $L = 79$ mH, $R_g = 25$ Ω , $I_{AS} = 5$ A, $V_{GS} = 10$ V.

Characteristics at $T_a = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at $I_D = 250\ \mu\text{A}$	BV_{DSS}	650	-	-	V
Drain-Source Leakage Current at $V_{DS} = 650\ \text{V}$, $V_{GS} = 0\ \text{V}$	I_{DSS}	-	-	1	μA
Gate Leakage Current at $V_{GS} = \pm 30\ \text{V}$	I_{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$	$V_{GS(th)}$	2	-	4	V
Drain-Source On-State Resistance at $V_{GS} = 10\ \text{V}$, $I_D = 10\ \text{A}$	$R_{DS(on)}$	-	150	190	m Ω
DYNAMIC PARAMETERS					
Gate Resistance at $V_{DS} = 0\ \text{V}$, $V_{GS} = 0\ \text{V}$, $f = 1\ \text{MHz}$	R_g	-	1	-	Ω
Input Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 100\ \text{V}$, $f = 1\ \text{MHz}$	C_{iss}	-	1479	-	pF
Output Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 100\ \text{V}$, $f = 1\ \text{MHz}$	C_{oss}	-	91	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 100\ \text{V}$, $f = 1\ \text{MHz}$	C_{rss}	-	10	-	pF
Gate Charge Total at $V_{DS} = 350\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 10\ \text{A}$	Q_g	-	45	-	nC
Gate to Source Charge at $V_{DS} = 350\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 10\ \text{A}$	Q_{gs}	-	9	-	nC
Gate to Drain Charge at $V_{DS} = 350\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 10\ \text{A}$	Q_{gd}	-	21	-	nC
Turn-On Delay Time at $V_{DD} = 350\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 10\ \text{A}$, $R_g = 24\ \Omega$	$t_{d(on)}$	-	60	-	ns
Turn-On Rise Time at $V_{DD} = 350\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 10\ \text{A}$, $R_g = 24\ \Omega$	t_r	-	22	-	ns
Turn-Off Delay Time at $V_{DD} = 350\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 10\ \text{A}$, $R_g = 24\ \Omega$	$t_{d(off)}$	-	60	-	ns
Turn-Off Fall Time at $V_{DD} = 350\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 10\ \text{A}$, $R_g = 24\ \Omega$	t_f	-	28	-	ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at $I_S = 10\ \text{A}$, $V_{GS} = 0\ \text{V}$	V_{SD}	-	-	1.2	V
Body-Diode Continuous Current	I_S	-	-	18	A
Body-Diode Continuous Current, Pulsed	I_{SM}	-	-	64	A
Body Diode Reverse Recovery Time at $I_S = 10\ \text{A}$, $di/dt = 100\ \text{A} / \mu\text{s}$	t_{rr}	-	330	-	ns
Body Diode Reverse Recovery Charge at $I_S = 10\ \text{A}$, $di/dt = 100\ \text{A} / \mu\text{s}$	Q_{rr}	-	4.5	-	μC

Electrical Characteristics Curves

Fig. 1 Typical Output Characteristics

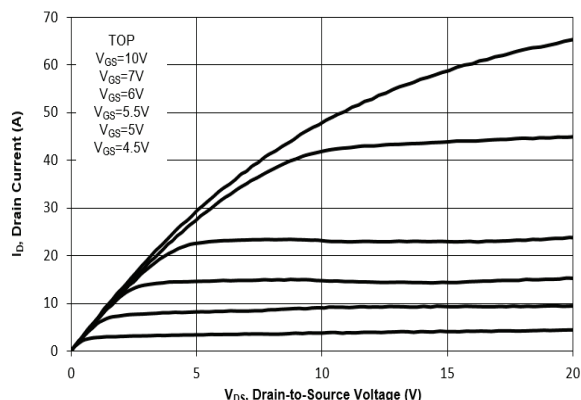


Fig. 2 Typical Transfer Characteristics

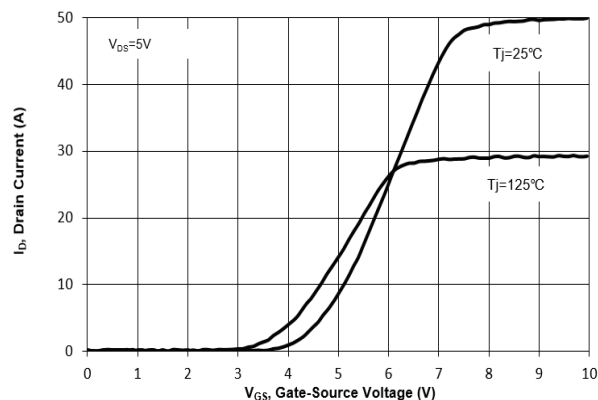


Fig. 3 On-Resistance vs. Drain Current

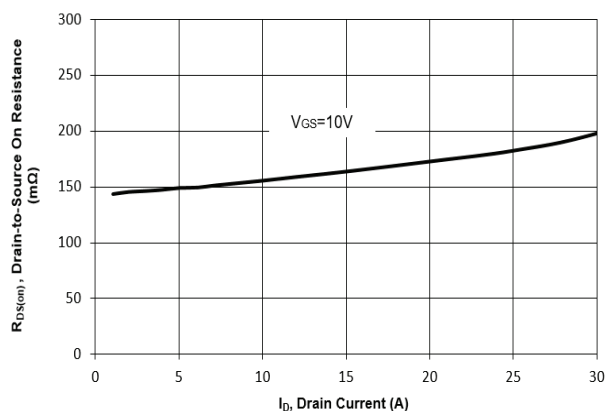


Fig. 4 On-Resistance vs. Gate to Source Voltage

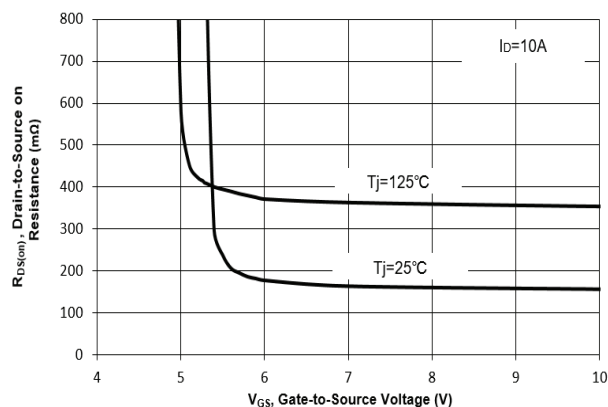


Fig. 5 On-Resistance vs. T_J

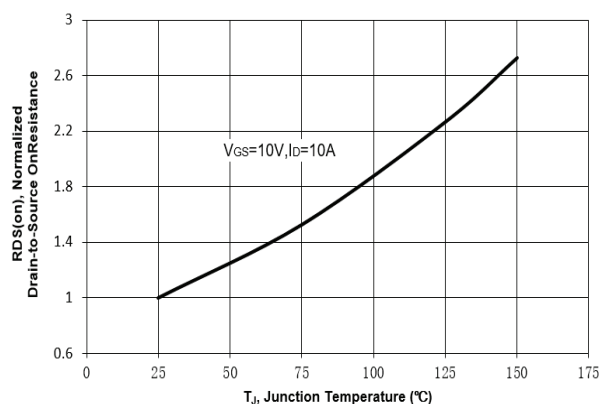
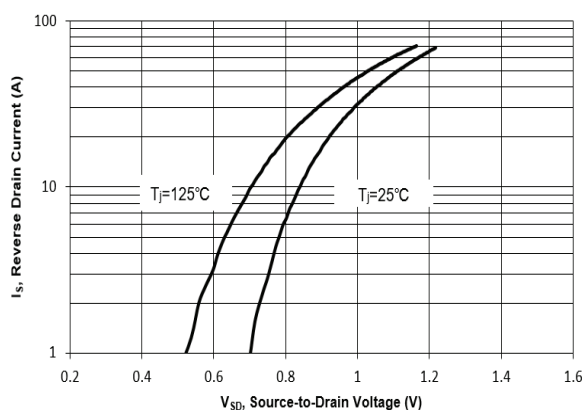


Fig. 6 Typical Body-Diode Forward Characteristics



Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

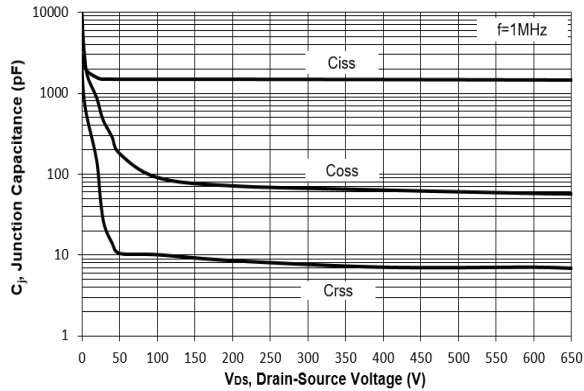


Fig. 8 Drain-Source Leakage Current vs. T_j

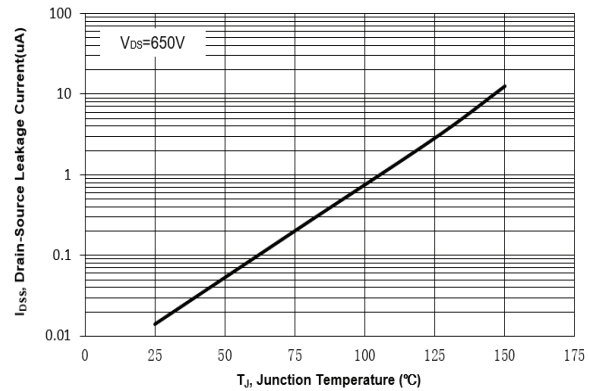


Fig. 9 $V_{(BR)DSS}$ vs. Junction Temperature

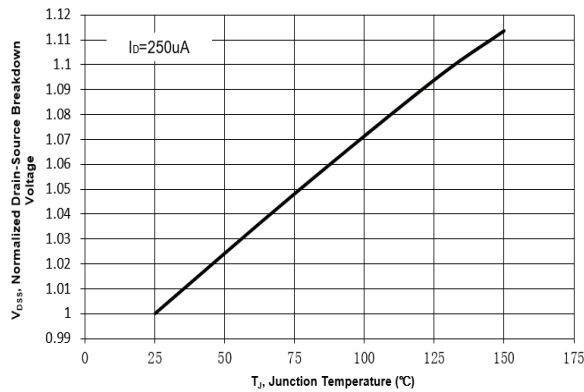


Fig. 10 Gate Threshold Variation vs. T_j

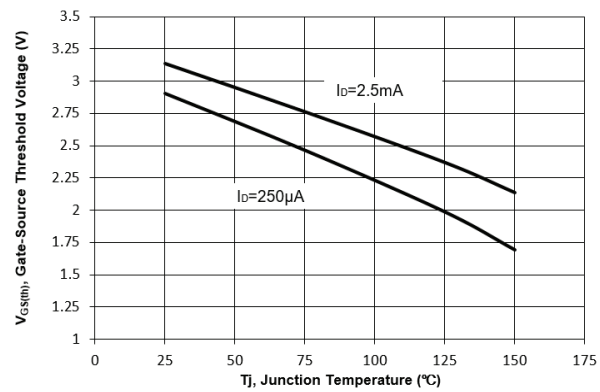


Fig. 11 Gate Charge

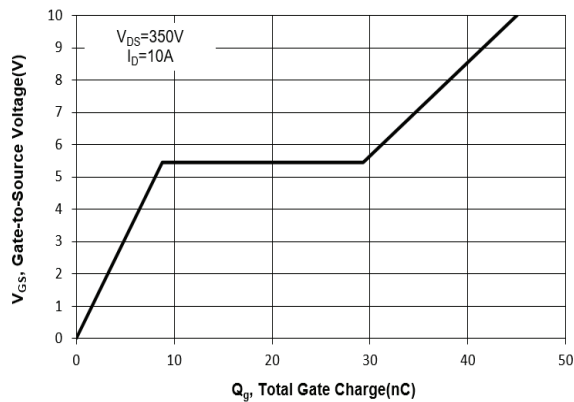


Fig. 12 Safe Operation Area

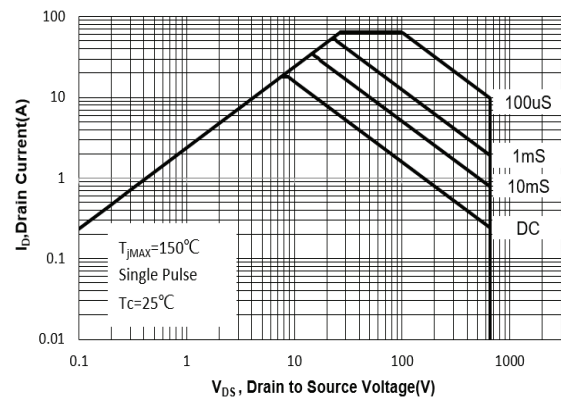


Fig.13 Normalized Maximum Transient Thermal Impedance($z_{\theta JC}$)

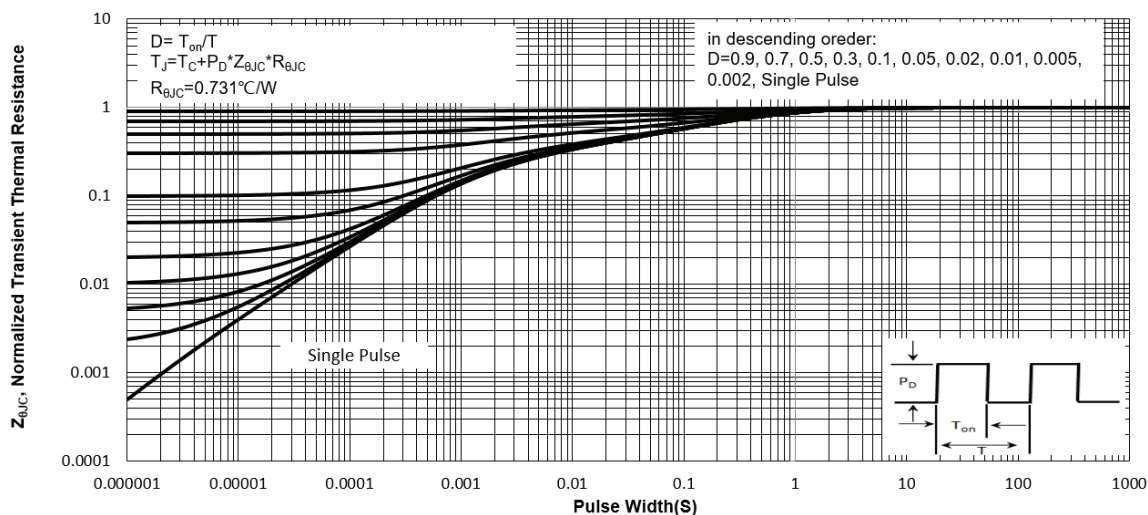
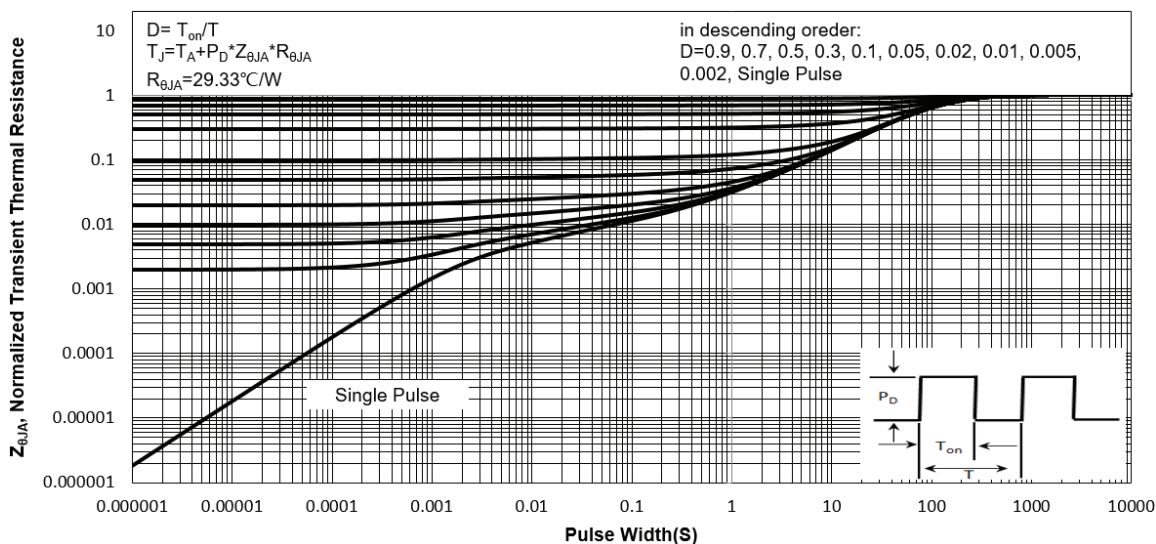


Fig.14 Normalized Maximum Transient Thermal Impedance($z_{\theta JA}$)



Test Circuits

Fig.1-1 Switching times test circuit

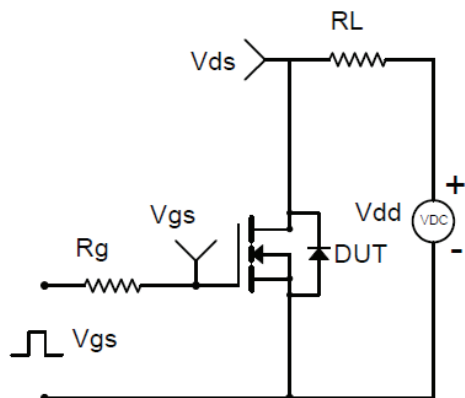


Fig.1-2 Switching Waveform

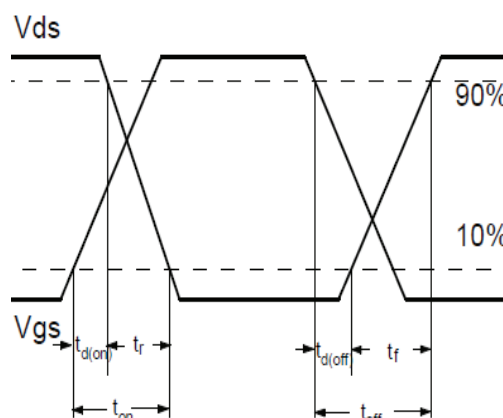


Fig.2-1 Gate charge test circuit

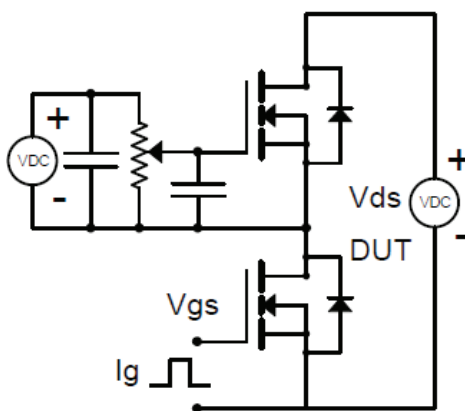


Fig.2-2 Gate charge waveform

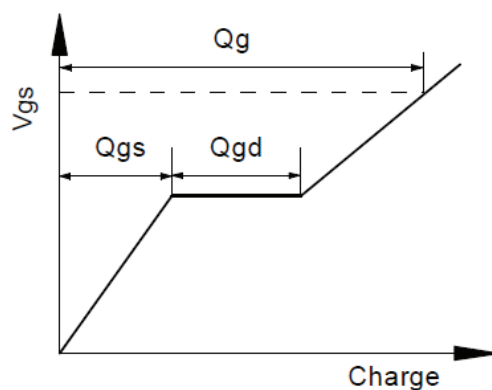


Fig.3-1 Avalanche test circuit

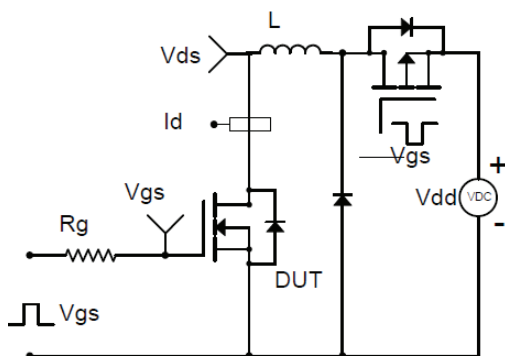
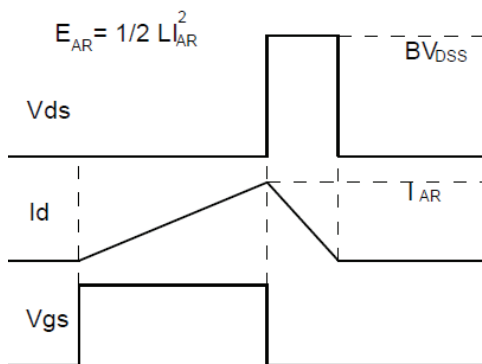
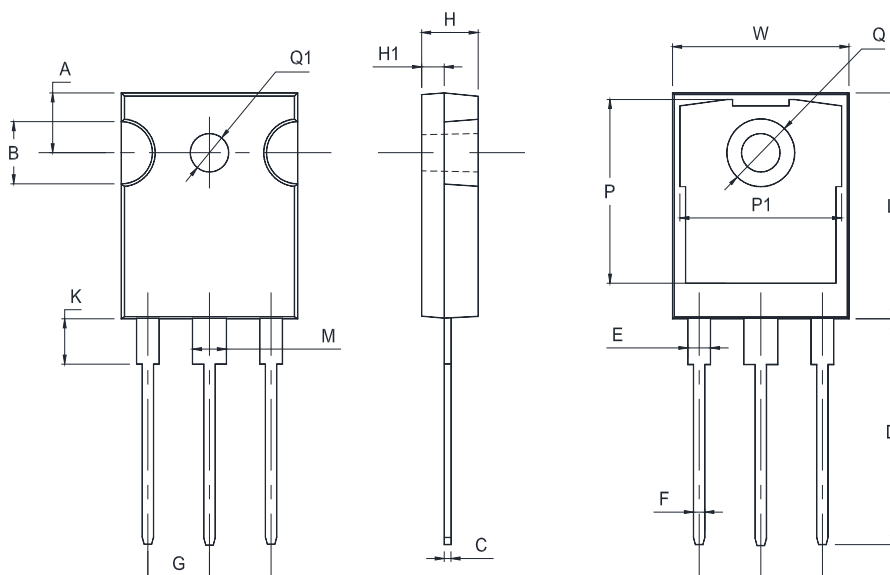


Fig.3-2 Avalanche waveform



Package Outline Dimensions (Units: mm)
TO-247


UNIT	A	B	C	D	E	F	G	W	H	H1	K	L	M	P
mm	6.5	5.2	0.7	20.3	2.2	1.3	5.7	16.2	5.3	2.5	4.45	21.3	3.2	16.6
	5.9	4.6	0.5	19.7	1.8	1.1	5.1	15.8	4.7	2.1	4.05	20.7	2.8	16.2

UNIT	P1	Q	Q1
mm	14.2	7.35	4.2
	13.8	7.05	3.6

Packing information

Package	Carton Quantity	Box Quantity	Base Quantity	Delivery Mode
TO-247	2.88 K / Carton	720 pcs / Box	30 pcs / Tube	Tube

Marking information

" PPT65N190 " = Part No

" ***** " = Date Code Marking

Font type: Arial



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